### **1.0 Description**

The AMIS-710650-A6 (PI650MC-A6C) is a color contact image sensor (CIS) module. The module contains seven image sensor chips, AMIS-720058 (PI6058H), a product of AMI Semiconductor. These chips are sequentially cascaded to provide a line array of photodetectors. Each photo-detector in the image sensor possesses its own independent processing circuit. As the photo-sensors' digital shift register scans the image sensor chip, it sequentially produces the video signals at the output of the image array. The AMIS-710650-A6's mechanical outline drawing is shown in Figure 6.

#### 2.0 Key Features

- 600 and 300dpi selectable resolutions
- 23.6dpm and 11.8dpm, 102mm scanning length
- 344 or 172 image sensor elements (pixels)
- Low power-single power supply at 3.3V
- · Light source, lens and sensor are integrated into a single module
- High speed page scan up to 602µsec/line @ 4MHz pixel rate
- Analog output
- RGB color LED light source
- Compact size 
   <sup>∞</sup> 12.3mm x 18.9mm x 125mm
- · Light weight

#### 3.0 Overview

The AMIS-710650-A6 has a 102mm read width. Its minimum line rate is 602us/line with a maximum clock pulse (CP) equal to 4.0MHz (pixel rate (PRATE), of 4.0MHz). Unless stated otherwise, all data was taken with CP = 3.0MHz (PRATE = 3.0MHz) and an integration time of 685us/line. The sensor photo-site density is 23.64elements/mm. The module has one analog video output, two clock inputs, clock and start pulse (CP and SP), one reference voltage input for the amplifier output bias level control, one power supply input and four LED inputs.

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#### 4.0 Scan Overview

Table 1 describes a scan overview.

#### Table 1: Scan Overview

Parameter	Specification	Note
Read width	102mm	
Sensor photo-site density	42.3 elements/mm	600dpi
	84.7 elements/mm	300dpi
Active photo elements	2408 elements	
Line read time <sup>(1)</sup>	~ 602µs/line	Tested @ 4.0MHz (PRATE)
Clock frequency <sup>(1)</sup>	4.0MHz	Max. rate
Pixel rate <sup>(1)</sup>	4.0MHz	Max. rate

Note:

(1) Since the light power is fixed, if the line-scan rate is set proportional to the clock rate, then the integration time reduces as the clock frequency is increased, hence its exposure. The reduction in the exposure proportionately reduces the video output. Accordingly, the signal-to-noise ratio reduces as the frequency increased.



### **5.0 Physical Overview**

Table 2 describes a physical overview.

Table 2: Physical Overview

Parameter	Specification	Note	
Image sensors	AMIS-720058	See image sensor data sheet	
Module outside dimension	≅125mm x 18.9mm x 12.5mm	Figure 6	
Circuit power supply	Typical 3.3V @ 50mA		
Data output	One analog output		

#### **6.0 Recommended Operating Conditions**

All tests were conducted at the typical pixel rate of 3.0MHz.

Table 3: Recommended Operating Conditions (25°C)

Parameter	Symbol	Min.	Typ.	Max.	Units
Power supply	VDD		3.3		V
	IDD		35		mA
Video output level	VP <sup>(1)</sup>	0.15	0.2		V
Reference voltage input	VREF <sup>(2)</sup>		1.2		V
Input voltage for digital high (input clocks, SP and CP)	VIH	3.2	VDD	VDD +0.3	V
Input voltage for digital low (input clocks SS and CP)	VIL	0		0.8	V
Clock frequency	FREQ (3)	0.50	3.0	4.0	MHz
Pixel frequency	PRATE (3)	0.50	3.0	4.0	MHz
Clock pulse high duty cycle	DUTY <sup>(4)</sup>		50		%
Clock pulse high duration	TPW	200			ns
Integration time	TINT (5)	~602		10000	μs
Operating temperature	TOP (6)		25	50	°C

Notes:

(1) VP represents the average value Vp(n) for all n in line scans, where n is the sequential number of a pixel. This signal pixel level should be operated at less than the sequential number of a pixel. This signal pixel level should be operated at less than the sequence saturation levels, i.e., <1.3V.

WWW.Det S VREF is used to adjust the video output bias. Under normal operation it is left unconnected.

(3) FREQ is the input clock (CP) frequency and the pixel rate (PRATE). The minimum rate for FREQ and PRATE should be consistent with the maximum TINT, see Note 5.

(4) DUTY is the ratio of the clock's pulse width to its pulse period.

(5) TINT is the time interval between two start pulses (SP). Hence, if SP is generated from a clock count down circuit, it will be directly proportional to the clock frequency. There must be a minimum of (56+1204) clock cycles between the two SPs. The longest integration time is determined by the degree of leakage current degradation that can be tolerated by the system. A 10ms maximum is a typical rule-of-thumb. An experienced CIS user can use his discretion to determine the desired leakage tolerance level for the given system.

(6) TOP is a conservative engineering estimate. It is based on measurements of similar CIS modules. In production, they are measured under standard QA practices, that is, under the control of ISO 9000 standards.



## 7.0 Electro-Optical Characteristics (25°C)

All tests were conducted at the typical pixel rate of 3.0MHz.

#### Table 4: Electro-Optical Characteristics (25°C)

Parameter	Symbol	Тур.	Units	Note
Number of active photo detectors		2408	Elements	600dpi
·		1204		300dpi
Pixel-to-pixel spacing		42.3	μm	600dpi
		84.6		300dpi
Line scan rate	TINT <sup>(1)</sup>	~820	µs/line	@ 3.0MHz clock frequency
Clock frequency	FREQ (2)	3.0	MHz	
Pixel rate	PRATE (2)	3.0	MHz	
Bright output voltage	Vpavg <sup>(3)</sup>	0.2	V	
Bright output non-uniformity	+/- Up <sup>(4)</sup>	< /-30	%	
Bright output total non-uniformity	Uptotal (5)	<60	%	
Adjacent pixel non-uniformity	Uadj <sup>(6)</sup>	<25	%	
Dark non-uniformity	Ud <sup>(7)</sup>	<150	mV	
Dark output voltage range	VDL <sup>(8)</sup>	1.2 <vdl<1.5< td=""><td>V</td><td></td></vdl<1.5<>	V	
Random noise	RNL <sup>(9)</sup>	<24	p-p mV	
		<4	rms mV	
Modulation transfer function	MTF (10)	40	%	

Notes:

- (1) Scan rate (integration time), TINT, is determined by the time interval between two SPs. See Table 3, Note 5.
- (2) Clock frequency, FREQ, is the input clock frequency and its corresponding PRATE is the pixel sample rate.
- (3) Bright output voltage Vpmax = maximum pixel value of Vp(n), Vpmin = minimum pixel value of Vp(n), Vpavg = ∑ Vp(n)/2408; where Vp(n) is the n<sup>th</sup> pixel in a line scan with the module scanning a uniform white target and Vp values are measured with a uniform exposure.
- (4) Bright output non-uniformity Up(+) = [(Vpmax Vpavg) / Vpavg] x 100%, Up(-)= [(Vpavg Vpmin) / Vpavg] x 100%, whichever polarity with the highest absolute value is selected.
- (5) Bright output total non-uniformity: Uptotal = [Vpmax -Vpmin]/Vpavg x 100%
- (6) Adjacent pixel non-uniformity: Upadj = MAX[ | (Vp(n) Vp(n+l) | / Vp(n))] x 100%
- Upadj is the non-uniformity in percentage. It is the maximum difference amplitude between two neighboring pixels.
- (7) Dark non-uniformity: Ud = Vdmax Vdmin
- Vdmax is the max. pixel value of the video pixel in the dark. Vdmin is the min. pixel value of the video pixel in the dark. The references for these levels are the dark level (VDL).
- (8) Dark output voltage range (VDL) is the level between the output dark level and ground.
- (9) Random noise (RNL): The rms value was calculated from measured p-p thermal noise taken at output from a selected pixel. The rms is defined as one standard deviation of at least 64 pixels sampled. The calculation of the standard deviation is based on an idealized Gaussian probability curve.
- (10) Modulation transfer function is defined as MTF = [(Vmax Vmin) / (Vmax + Vmin)] x 100%. MTF is a measure at the glass surface. Vmax is the maximum output voltage at 300lp/inch (at 1/2 of the optical Nyquest frequency) and Vmin is the minimum output voltage at 300lp/inch.

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## **8.0 Electrical Clocking Characteristics**

#### Table 5: Clock Amplitude Duty Characteristics (25°C)

Parameter	Symbol	Min.	Тур.	Max.	Units
Clock input voltage	VIH <sup>(1)</sup> VIL <sup>(1)</sup>		See Table 3		
Clock frequency	FREQ (2)	Note (3)	3.0	4.0	MHz
Pixel rate	PRATE (2)	~0.620	3.0	4.0	MHz
Line read time	TINT <sup>(4)</sup>	45		~10	ms
Clock pulse duty cycle	Ratio = twp / tp <sup>(5)</sup>				%

Notes:

(1) The clocks, CP and SP are compatible with CMOS clock drivers.

(2) FREQ is the clock frequency and PRATE is the pixel sample rate.

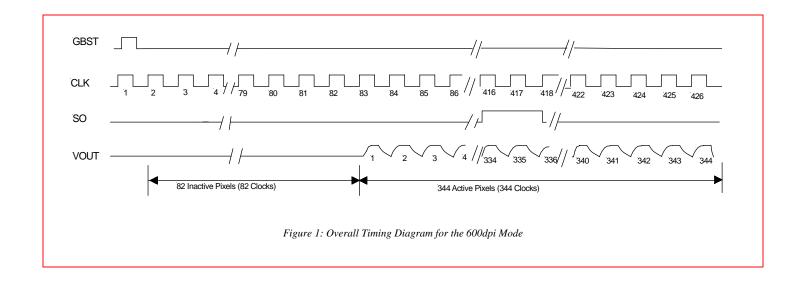
(3) Minimum values are not specified because it will be determined by the maximum TINT value. See Note 4.

(4) TINT is the line scan read time, which depends on the interval between the SP entries. The minimum time is determined by (1/clock frequency) x (2408 + 150) pixels. Note that there are a few extra pixels used to determine the typical line time of 820µsec @ 3.0MHz PRATE (see Section 9.0). There are 55 clocks required to transfer and reset the photo-sites before the video can be scanned out. The longest integration time is determined by the degree of leakage current degradation that can be tolerated by the system. A 10ms maximum is a typical rule-of-thumb. An experienced CIS user can use his discretion and determine the desired tolerance level for the given system.

(5) The definition for the symbols used in the ratio is defined in Table 6. A duty cycle of exactly 50 percent is recommended to maintain equal pixel duration between odd and even pixels.



### 9.0 Timing Diagram



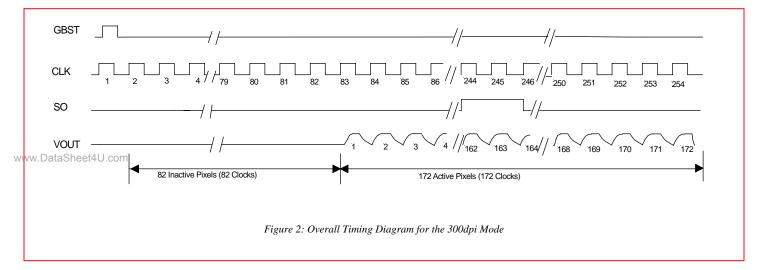
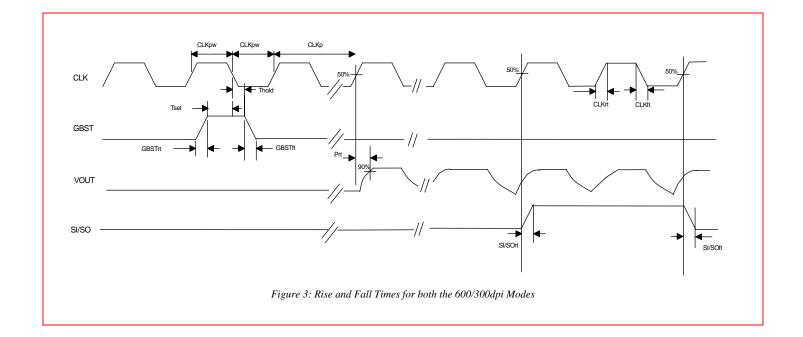


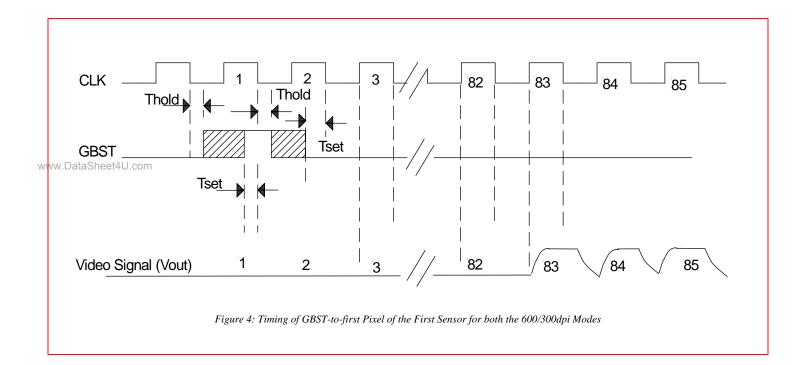
Figure 1 and Figure 2 detail the timing of the CLK, GBST, Vout, and SI/SO signals in further detail, which have the same timing requirements for both the 600 and 300dpi modes. In Figure 1, note that Pixel 83 is the first active pixel because the first 82 pixels are dummy pixels.



## AMIS-710650-A6: Color CIS Module

Analog Video Output







AMI Semiconductor - Aug. 06, M-20611-001

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# AMIS-710650-A6: Color CIS Module

Analog Video Output

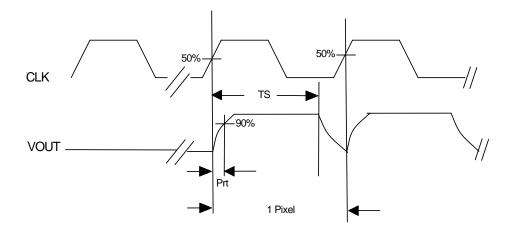


Figure 5: Pixel Timing

All tests were conducted at the typical pixel rate of 3.0MHz.

Table 6: Clock Timing Characteristics for Timing Diagrams						
Parameter	Symbol	Min.	Тур.	Max.	Units	
Clock cycle time	CLKp	250	250		ns	
Clock pulse width	CLKpw		125		ns	
Clock duty cycle			50		%	
Prohibit crossing time SP	tprh	30			ns	
Data setup time	Tset	30			ns	
Data hold time	Thold	30			ns	
Signal delay time	tdl			50	ns	
Signal settling time	tst			130	ns	
Signal fall time	tsigf			60	ns	

Notes:

(1) All of the symbol definitions used in Table 6 are shown in the figures in Section 9.0. The clocks, CP and SP are compatible with CMOS clock drivers.

## **10.0 Maximum Ratings**

#### Table 7: Maximum Ratings (Not to be Used for Continuous Operation)

Parameter	Symbol	Specification	Note
Power supply voltage	VDD	3.3V	
Input voltage	VIN	VDD	SP & CP
Ambient temperature	TA (PCB surface)	0 to 50 C -10 to +75 C	Operational storage
Ambient humidity	HA	0 to 80%	Non-condensing
Maximum operating case temperature	PCB temperature	70 <sup>°</sup> C	



## **11.0 I/O Connector Pin Configuration**

The connector is for a 12-pin flex-strip-line cable, PDK97-1201. The connector location is shown in Figure 6, an ISO drawing of the AMIS-710650-A6 module. It also shows the location of Pin 1.

#### Use caution when connecting the power to the LED!

Note that all the negative sides of the LED sources are connected to the cathodes. These I/O sources are current inputs. Constant current sources are used to control the balance of the color in the RGB outputs. Their typical voltage drops are between 2.3 to 2.7V. Under no circumstances should the applied current be greater than 30mA, otherwise the LED source will be damaged.

Table 8: Conne	ector Pin Outs			
Pin Number	Pin Names	Symbol	I/0	Names and Functions
1	Analog signal output	VOUT	0	Analog signal output
2	Ground	GND	I	Ground; 0V
3	Power supply	VDD	I	Positive 3.3V
4	DPI-control	SR	I	Selects resolution control
5	Reference voltage	VREF	I	For externally or internally controlling the dark bias level
6	Start pulse	SP	I	Shift register start pulse
7	Ground	GND	1	Ground; 0V
8	Clock	CP (CLK on the schematic)	I	Clock input for the module
9	Common	VLED (common anode on the schematic)	1	Common anodes for all LED, plus 5.0V terminal
10	LED Green	GLED	1	Cathode green LED input
11	LED Red	RLED		Cathode red LED input
12	LED Blue	BLED	I	Cathode blue LED input

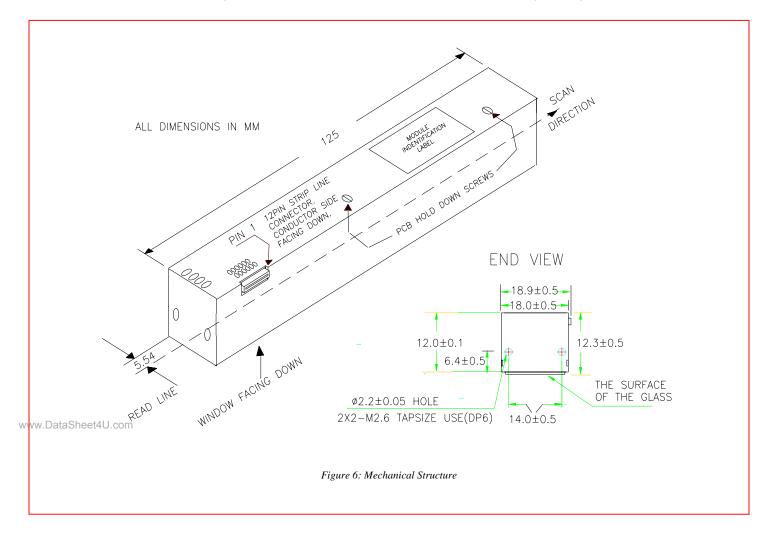
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# AMIS-710650-A6: Color CIS Module

#### **12.0 Mechanical Outline Drawing**

A simplified ISO drawing of the module housing is shown Figure 6. The drawing is not to scale but sufficient dimensions are shown for use in a preliminary application study. Furthermore, it shows the I/O connector location, its Pin 1 location, the read line location and LED pad locations. For detailed design information, please contact AMIS for a complete housing drawing.





#### **13.0** Company or Product Inquiries

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